ASSOCIATION CONNECTING ELECTRONICS INDUSTRIES	Material Composit © Copyright 2005. IPC, international and Pan-An	t ion Dec Bannockb nerican co	c laration ourn, Illinois. A opyright conver	Il rights reserved nations.	under both	This docume level parts, th	ent is a declar he declaratio	ration o n encor	of the substand mpasses all lo	ces withi	n the manufac l materials for	turer listed i which the n	tem. No nanufac	ote: if th cturer ha	e item is an as s engineering	sembly with low responsibility.
	IPC Web Site for Information on IPC-1752 Standard Form Type http://www.ipc.org/IPC-175x Distribute					e *	Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materials and Mfg Information									
upplier Informat	ion															
Company name* Company unique ID					1	Unique ID Authority					Respon	Response Date*				
nsemi							2025-06-08									
ontact Name	Title - Contact]	Phone - Contact*				Email -	Email - Contact*						
Product-Env-Stewards	5		Product Enviro Compliance				NA				Produc	Product-Env-Stewards@onsemi.com				
Authorized Representative*			Title - Representative			Phone - Representative*				Email -	Email - Representative*					
Product-Env-Stewards			Product Enviro Compliance				NA				Produc	Product-Env-Stewards@onsemi.com				
Requester It	Requester Item Number Mfr Iter		Number Mfr Item Name			Effective Date Version Manufacturing Sit		facturing Site		Weight	*	UOM	Unit Type			
	MT9V034C12STC- DR			5		2025-06-08	025-06-08 TWU				776.08		mg	Each		
Ianufacturing Pro	occess Information	1														
Terminal Plating / Grid Array Material Terminal Base Alloy			Alloy	J-STD-020 MS	-020 MSL Rating Pe			Peak Process Body Temperature Max Time at Peak			ak Tempera	ture N	Number (of Reflow Cyc	eles	
Precious metal (e.g. Ag,Au, NiPdAu) (no Sn) CU Alloy			4		260		C	30)	secon	ids 3	5				
omments																
or more information 1	regarding material com	position	please refer to	page 3												

RoHS Material Composition Declaration				Declaration Type *	Detailed							
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Disobutyl phthalate (DIBP).											
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe y others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of							
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	ances per the definitio	on above	Supplier Acceptance	* Accepted							
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all							
Exemption List Version	EL-2011/534/EU											
Declaration Signature												
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the							
Supplier Digital Signature Ra	stislav Drska	Le										

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Ceramic Substrate	542.28	mg	Supplier	Cobalt (Co)	7440-48-4		0.705	mg
		-	Supplier	Titanium Dioxide (TiO2)	13463-67-7		5.4228	mg
			Supplier	Molybdenum (Mo)	7439-98-7		5.4228	mg
			Supplier	Tungsten (W)	7440-33-7		22.83	mg
			Supplier	Magnesium Monoxide (MgO)	1309-48-4		3.2537	mg
			Supplier	Calcium Oxide (CaO)	60873-85-0		2.7656	mg
			Supplier	Silica Amorphous (SiO2)	7631-86-9		15.1838	mg
			Supplier	Aluminum Trioxide (Al2O3)	1344-28-1		462.2937	mg
			В	Nickel (Ni)	7440-02-0		2.2233	mg
			Supplier	Gold (Au)	7440-57-5		1.3557	mg
			Supplier	Chromium Trioxide (Cr2O3)	1308-38-9		20.8236	mg
Die	49.22	mg		Misc.	proprietary data		0.187	mg
			Supplier	Silicon (Si)	7440-21-3		48.5457	mg
			Supplier	Aluminum (Al)	7429-90-5		0.4873	mg
Die Attach	25.14	mg	Supplier	Bisphenol A_Epichlorohydrin Polymer	25068-38-6		1.0835	mg
			Supplier	Epoxy resins	129915-35-1		7.7607	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		9.1535	mg
			Supplier	Acrylic resins	Proprietary Data		7.1423	mg
Imaging Lens	151.66	mg	Supplier	Titanium Dioxide (TiO2)	13463-67-7		7.9622	mg
			Supplier	Sodium Monoxide (Na2O)	1313-59-3		7.7347	mg
			Supplier	Boron Trioxide (B2O3)	1303-86-2		7.9622	mg
			Supplier	Zinc Monoxide (ZnO)	1314-13-2		7.7802	mg
			В	Antimony Trioxide (Sb2O3)	1309-64-4		0.7583	mg
			Supplier	Aluminum Trioxide (Al2O3)	1344-28-1		7.6588	mg
			Supplier	Potassium Monoxide (K2O)	12136-45-7		7.674	mg
			Supplier	Silica Crystalline (SiO2)	14808-60-7		104.1298	mg
Lid Attach	5.79	mg		Other Additive Agents	proprietary data		1.0086	mg
		-	Supplier	Photoinitiator	Proprietary Data		0.2362	mg
			Supplier	Epoxy Prepolymer	Proprietary Data		4.5452	mg
Aarking Ink	0.05	mg	Supplier	Bisphenol A_Epichlorohydrin Polymer	25068-38-6		0.042	mg
-		-	Supplier	1-Methoxy-2-propyl acetate (MPA)	108-65-6		0.0024	mg
			Supplier	Butylglycol Acetate	112-07-2		0.0024	mg

			Supplier	Cyclohexanone	108-94-1	0.0025	mg
			Supplier	Xylene	1330-20-7	0.0007	mg
Wire Bond - Au	1.94	mg	Supplier	Gold (Au)	7440-57-5	1.94	mg